SDLS107 - OCTOBER 1976 - REVISED MARCH 1988

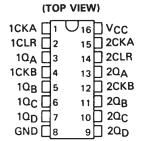
- Dual Versions of the Popular '90A, 'LS90 and '93A, 'LS93
- '390, 'LS390 . . . Individual Clocks for A and B Flip-Flops Provide Dual ÷ 2 and ÷ 5 Counters
- '393, 'LS393... Dual 4-Bit Binary Counter with Individual Clocks
- All Have Direct Clear for Each 4-Bit Counter
- Dual 4-Bit Versions Can Significantly Improve System Densities by Reducing Counter Package Count by 50%
- Typical Maximum Count Frequency . . . 35 MHz
- Buffered Outputs Reduce Possibility of Collector Commutation

description

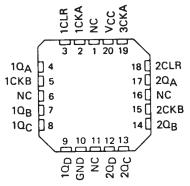
Each of these monolithic circuits contains eight master-slave flip-flops and additional gating to implement two individual four-bit counters in a single package. The '390 and 'LS390 incorporate dual divide-by-two and divide-by-five counters, which can be used to implement cycle lengths equal to any whole and/or cumulative multiples of 2 and/or 5 up to divide-by-100. When connected as a bi-quinary counter, the separate divide-by-two circuit can be used to provide symmetry (a square wave) at the final output stage. The '393 and 'LS393 each comprise two independent four-bit binary counters each having a clear and a clock input. N-bit binary counters can be implemented with each package providing the capability of divide-by-256. The '390, 'LS390, '393, and 'LS393 have parallel outputs from each counter stage so that any submultiple of the input count frequency is available for system-timing signals.

Series 54 and Series 54LS circuits are characterized for operation over the full military temperature range of -55°C to 125°C; Series 74 and Series 74LS circuits are characterized for operation from 0°C to 70°C.

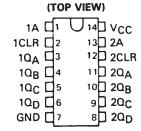
SN54390, SN54LS390 . . . J OR W PACKAGE SN74390 . . . N PACKAGE SN74LS390 . . . D OR N PACKAGE



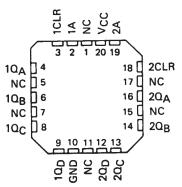
SN54LS390 . . . FK PACKAGE (TOP VIEW)



SN54393, SN54LS393 . . . J OR W PACKAGE SN74393 . . . N PACKAGE SN74LS393 . . . D OR N PACKAGE



SN54LS393 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection



SDLS107 - OCTOBER 1976 - REVISED MARCH 1988

'390, 'LS390
BCD COUNT SEQUENCE
(EACH COUNTER)
(See Note A)

COUNT		συτ	PUT	
COONT	σ_{D}	σc	σ_{B}	QA
0	L	L.	L	L
1	L	L	L	н
2	L	L	Н	ᆸ
3	L	L	Н	н
4	L	Н	L	ᅵ
5	L	Н	L	н
6	L	Н	Н	ᅵᅵ
7	L	Н	Н	н
8	н	L	L	L
9	Н	L	L	Н

FUNCTION TABLES
'390, 'LS390
BI-QUINARY (5-2)
(EACH COUNTER)
(See Note B)

COLUNIT		OUT	PUT	
COUNT	QΑ	a_{D}	αc	$oldsymbol{Q}_{B}$
0	L	L	L	٦
1	L	L	L	н
2	L	L	Н	L
3	L	L	Н	н
4	L	Н	L	L
5	н	L	L	L
6	н	L	L	Н
7	н	L	Н	L
8	н	L	Н	Н
9	Н	Н	L	L

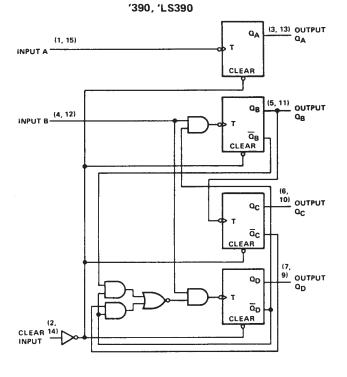
'393, 'LS393 COUNT SEQUENCE (EACH COUNTER)

COUNT		OUT	PUT	
CODIVI	a_{D}	αc	Q_{B}	QA
0	L	L	L	L
1	L	L	L	н
2	L	L	Н	L
3	L	L	Н	н
4	L	Н	L	L
5	L	Н	L	н
6	L	н	Н	L
7	L	Н	Н	-н
8	н	L	L	ᅵᅵ
9	н	L	L	н
10	н	L	н	L
11	н	L	Н	н
12	н	Н	L	L
13	н	Н	L	н
14	н	Н	Н	L
15	н	Н	Н	н

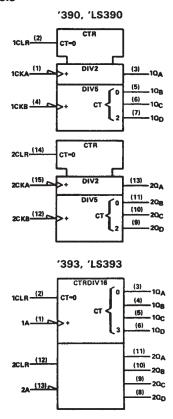
NOTES: A. Output QA is connected to input B for BCD count,

- B. Output Q_D^{\frown} is connected to input A for bi-quinary
 - count.
- C. H = high level, L = low level.

logic diagrams (positive logic)



logic symbols†

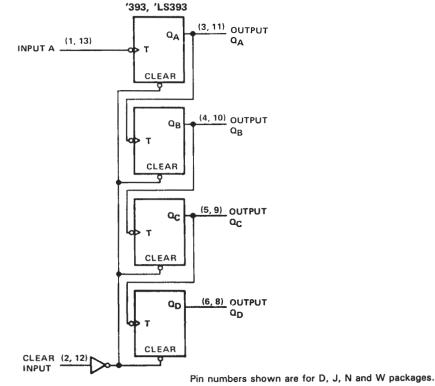


[†]These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

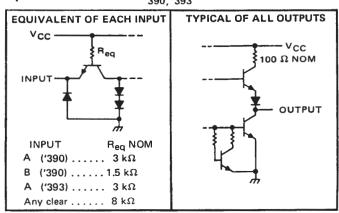




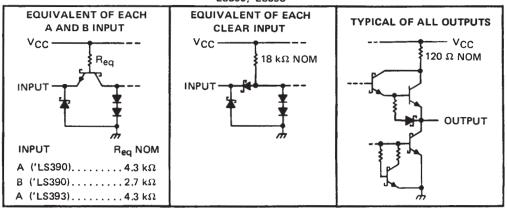


schematics of inputs and outputs

'390, '393



'LS390, 'LS393





SDLS107 – OCTOBER 1976 – REVISED MARCH 1988

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	
Input voltage	
Operating free-air temperature range: SN54390, SN54393	
	0°C to 70°C
	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		- 1	SN5439 SN5439			SN7439 SN7439		UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	٧
High-level output current, IOH			-800			-800	μΑ	
Low-level output current, IOL				16			16	mA
Count francisco f	A input	0		25	0		25	MHz
Count frequency, f _{count}	B input	0		20	0		20	IVIDZ
	A input high or low	20			20			
Pulse width, t _W	B input high or low	25			25			ns
	Clear high	20			20		•	1
Clear inactive-state setup time, t _{su}	•	25↓			25↓			ns
Operating free-air temperature, TA	erating free-air temperature, TA			125	0		70	°C

 $[\]downarrow$ The arrow indicates that the falling edge of the clock pulse is used for reference.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	D		7507.00M	NTIONO!		′390			′393		
	PARAMETER		TEST CONE	NI IONS.	MIN	TYP‡	MAX	MIN	TYP [‡]	MAX	UNIT
VIH	High-level input voltage				2			2			V
VIL	Low-level input voltage						0.8			0.8	V
VIK	Input clamp voltage		VCC = MIN, I	≖ –12 mA			-1.5			-1.5	V
Vон	High-level output voltage		V _{CC} = MIN, V V _{IL} = 0.8 V, I _C		2.4	3.4		2.4	3.4		V
VOL	Low-level output voltage		V _{CC} = MIN, V V _{IL} = 0.8 V, I _C	***		0.2	0.4		0.2	0.4	V
11	Input current at maximum input voltage		V _{CC} = MAX, V	j = 5.5 V			1			1	mA
		Clear	,				40			40	
ин	High-level input current	Input A	V _{CC} = MAX, V	j = 2.4 V			80			80	μΑ
		Input B					120				
		Clear					1			-1	
HL	Low-level input current	Input A	V _{CC} = MAX, V	j = 0.4 V			-3.2			-3.2	mA
		Input B					-4.8				
100	Short-circuit output current §		V-0 = MAY	SN54'	-20		57	-20		-57	mA
los	Short-circuit output current's		V _{CC} = MAX	SN74'	-18		-57	-18		-57	IIIA
Icc	Supply current		V _{CC} = MAX, Se	ee Note 2		42	69		38	64	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: ICC is measured with all outputs open, both clear inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.



 $^{^{\}ddagger}$ All typical values are at V_{CC} = 5 V, T_A = 25 °C.

[§] Not more than one output should be shorted at a time.

The QA outputs of the '390 are tested at IOL = 16 mA plus the limit value for IIL for the B input. This permits driving the B input while maintaining full fan-out capability.

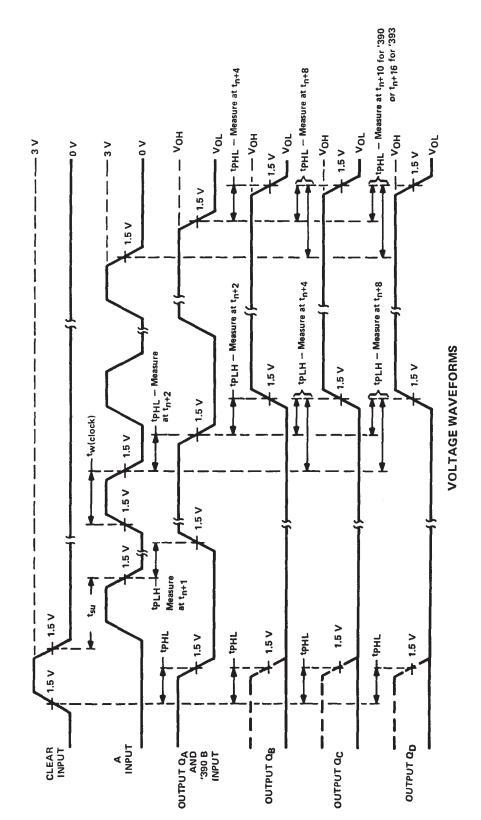
SDLS107 - OCTOBER 1976 - REVISED MARCH 1988

switching characteristics, V_{CC} = 5 V, T_A = 25°C

242445752	FROM	то	TEST CONDITIONS		′390			′393		UNIT
PARAMETER	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	Civil
,	Α	QΑ		25	35		25	35		MHz
f _{max}	В	QB		20	30					141112
^t PLH	А	0	1		12	20		12	20	ns
tPHL		Q _A			13	20		13	20	1113
^t PLH		Q _C of '390	Cլ=15 pF,		37	60		40	60	ns
tPHL.	Α	Q _D of '393	R _L = 400 Ω,		39	60		40	60	1113
^t PLH	В	_	See Note 3		13	21				ns
t _{PHL}	В	QB	and		14	21				115
t _{PLH}	В	0 -	Figure 1		24	39				ns
[†] PHL	P	αc			26	39				113
^t PLH	В	0-]		13	21				ns
^t PHL	B	α_{D}			14	21				113
t _{PHL}	Clear	Any			24	39		24	39	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

PARAMETER MEASUREMENT INFORMATION



NOTE A: Input pulses are supplied by a generator having the following characteristics t_r < 5 ns, t_f < 5 ns, PRR = 1 MHz, duty cycle = 50%, Z_{out} ≈ 50 ohms.

FIGURE 1



SDLS107 - OCTOBER 1976 - REVISED MARCH 1988

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)									 ٠.							. 7 V
Clear input voltage																
Any A or B clock input voltage									 							5.5 V
Operating free-air temperature range:	SN54	LS39	0, S	N54	LS39	3							-5	5°C	to	125°C
	SN74	LS39	0, S	N74	LS39	3								0°0	C to	70°C
Storage temperature range									 				-6	5°C	to	150°C
NOTE 1: Voltage values are with respect to netw																

recommended operating conditions

		_	N54LS				74LS390 74LS393 NOM MAX 5 5.25 -400 8 25 12.5		
		MIN	NOM	MAX	MIN	NOM	MAX		
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	٧	
High-level output current, IOH				-400			-400	μΑ	
Low-level output current, IOL				4			8	mA	
0	A input	0		25	0		25	MHz	
Count frequency, f _{count}	B input	0		12.5	0		12.5	IVIFIZ	
	A input high or low	20			20				
Pulse width, tw	B input high or low	40			40			ns	
	Clear high	20			20			1	
Clear inactive-state setup time, t _{su}		25‡			25↓			ns	
Operating free-air temperature, TA		55		125	0		70	°C	

The arrow indicates that the falling edge of the clock pulse is used for reference.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

							SN54L	S'		UNIT		
	PARAMETER		TES	T CONDITIONS		MIN	TYP‡	MAX	MIN	TYP‡	MAX	CIVIT
VIH	High-level input voltage					2			2			V
VIL	Low-level input voltage							0.7			0.8	V
VIK	Input clamp voltage		VCC = MIN,	I _I = -18 mA				-1.5			-1.5	V
Vон	High-level output voltage	1	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V, I _{OH} = -400 μA		2.5	3.4		2.7	3.4		V
.,			V _{CC} = MIN,	V _{IH} = 2 V,	IOL = 4 mA¶		0.25	0.4		0.25	0.4	V
VOL	Low-level output voltage		V _{IL} = 0.8 V,		IOL = 8 mA¶					0.35	0.5	
	Input ourroat at	Clear			V ₁ = 7 V			0.1			0.1	
Ц	Input current at maximum input voltage	Input A	V _{CC} = MAX		V ₁ = 5.5 V			0.2			0.2	mA
	maximum input vortage	Input B			V1 - 3.5 V			0.4			0.4	
		Clear						0.02	ļ		0.02	1
ΉΗ	High-level input current	Input A	$V_{CC} = MAX,$	$V_1 = 2.7 V$				0.1			0.1	mA
		Input B						0.2			0.2	
		Clear						-0.4			-0.4	1
HL	Low-level input current	Input A	VCC = MAX,	V1 = 0.4 V				-1.6			-1.6	4
		Input B						-2.4			-2.4	<u> </u>
IOS	Short-circuit output curi	rent§	V _{CC} = MAX			-20		-100	-20		-100	
Lan	Supply ourrent		VCC = MAX,		'LS390		15	26		15		-l mA
Icc	Supply current		See Note 2		'LS393		15	26		15	26	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: I_{CC} is measured with all outputs open, both clear inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.



 $^{^{\}ddagger}$ All typical values are at V_{CC} = 5 V, T_A = 25 °C.

[§] Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

¹ The QA outputs of the LS390 are tested at IOL = MAX plus the limit value for IIL for the clock B input. This permits driving the clock B input while maintaining full fan-out capability.

SN54390, SN54LS390, SN54393, SN54LS393 SN74390, SN74LS390, SN74393, SN74LS393 DUAL 4-BIT DECADE AND BINARY COUNTERS SDLS107 - OCTOBER 1976 - REVISED MARCH 1988

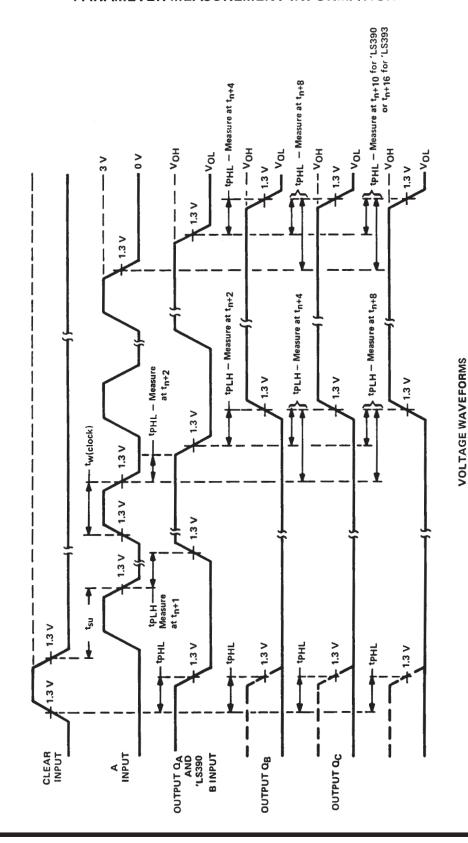
switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{ C}$

DADAMETED	FROM	то	7507 00MD1710M0		'LS390			'LS393		
PARAMETER	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
	А	QA		25	35		25	35		MHz
f _{max}	В	QΒ]	12.5	20					IVITIZ
tPLH	A	0.			12	20		12	20	
^t PHL	7 ^	Q _A			13	20		13	20	ns
^t PLH	Α	QC of 'LS390	C _L = 15 pF,		37	60		40	60	
^t PHL	1_^	Q _D of 'LS393	$R_{L} = 2 k\Omega$,		39	60		40	60	ns
^t PLH	В	0-	See Note 4 and Figure 2		13	21				
tPHL	1 -	QΒ			14	21				ns
tPLH .	В	0-			24	39				
tPHL.	1 6	σC			26	39				ns
^t PLH	В	0-			13	21				
^t PHL	1	σD			14	21				ns
tPH L	Clear	Any			24	39		24	39	ns

NOTE 4: Load circuits and voltage waveforms are shown in Section 1.



PARAMETER MEASUREMENT INFORMATION



NOTE A: Input pulses are supplied by a generator having the following characteristics t₁< 15 ns, t₁< 6 ns, PRR = 1 MHz, duty cycle = 50 %,

 $Z_{out} \approx 50$ ohms.

FIGURE 2





www.ti.com 2-Dec-2024

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
7802601EA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7802601EA SNJ54LS390J	Samples
7802601FA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7802601FA SNJ54LS390W	Samples
7802601FA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7802601FA SNJ54LS390W	Samples
JM38510/32701B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32701B2A	Samples
JM38510/32701B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32701B2A	Samples
JM38510/32701BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32701BEA	Samples
JM38510/32701BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32701BEA	Samples
JM38510/32702B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702B2A	Samples
JM38510/32702B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702B2A	Samples
JM38510/32702BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702BCA	Samples
JM38510/32702BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702BCA	Samples
JM38510/32702BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702BDA	Samples
JM38510/32702BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702BDA	Samples
JM38510/32702SDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702SDA SNV54LS393W	Samples
JM38510/32702SDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702SDA SNV54LS393W	Samples
M38510/32701B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32701B2A	Samples





2-Dec-2024 www.ti.com

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Sample
M38510/32701B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32701B2A	Samples
M38510/32701BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32701BEA	Samples
M38510/32701BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32701BEA	Samples
M38510/32702B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702B2A	Samples
M38510/32702B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702B2A	Samples
M38510/32702BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702BCA	Samples
M38510/32702BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702BCA	Samples
M38510/32702BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702BDA	Samples
M38510/32702BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702BDA	Samples
M38510/32702SDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702SDA SNV54LS393W	Samples
M38510/32702SDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32702SDA SNV54LS393W	Samples
SN54LS390J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS390J	Samples
SN54LS390J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS390J	Samples
SN54LS393J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS393J	Samples
SN54LS393J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS393J	Samples
SN74LS390D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS390	Sample
SN74LS390D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS390	Sample





2-Dec-2024 www.ti.com

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS390N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS390N	Samples
SN74LS390N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS390N	Samples
SN74LS390NE4	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS390N	Samples
SN74LS390NE4	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS390N	Samples
SN74LS390NSR	ACTIVE	SOP	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS390	Samples
SN74LS390NSR	ACTIVE	SOP	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS390	Samples
SN74LS393D	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	0 to 70	LS393	
SN74LS393D	OBSOLETE		D	14		TBD	Call TI	Call TI	0 to 70	LS393	
SN74LS393DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS393	Samples
SN74LS393DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS393	Samples
SN74LS393N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS393N	Samples
SN74LS393N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS393N	Samples
SN74LS393NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS393N	Samples
SN74LS393NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS393N	Samples
SN74LS393NSR	ACTIVE	SOP	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS393	Samples
SN74LS393NSR	ACTIVE	SOP	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS393	Samples
SNJ54LS390FK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 390FK	Samples
SNJ54LS390FK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 390FK	Samples
SNJ54LS390J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7802601EA SNJ54LS390J	Samples
SNJ54LS390J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7802601EA SNJ54LS390J	Samples
SNJ54LS390W	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7802601FA SNJ54LS390W	Samples



www.ti.com 2-Dec-2024

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54LS390W	ACTIVE	CFP	W	16	25	Non-RoHS & Green	(6) SNPB	N / A for Pkg Type	-55 to 125	7802601FA SNJ54LS390W	Samples
SNJ54LS393FK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 393FK	Samples
SNJ54LS393FK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 393FK	Samples
SNJ54LS393J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS393J	Samples
SNJ54LS393J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS393J	Samples
SNJ54LS393W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS393W	Samples
SNJ54LS393W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS393W	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

PACKAGE OPTION ADDENDUM

www.ti.com 2-Dec-2024

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54LS390, SN54LS393, SN54LS393-SP, SN74LS390, SN74LS393:

Catalog: SN74LS390, SN74LS393, SN54LS393

Military: SN54LS390, SN54LS393

Space : SN54LS393-SP

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and qualified for use in Space-based application

PACKAGE MATERIALS INFORMATION

www.ti.com 7-Dec-2024

TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS390NSR	SOP	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74LS393DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS393NSR	SOP	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



www.ti.com 7-Dec-2024



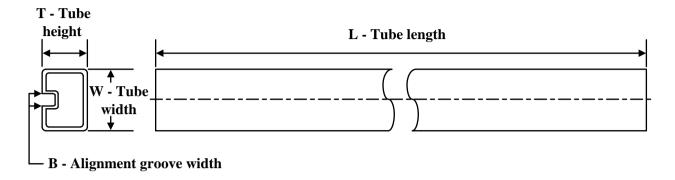
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS390NSR	SOP	NS	16	2000	356.0	356.0	35.0
SN74LS393DR	SOIC	D	14	2500	356.0	356.0	35.0
SN74LS393NSR	SOP	NS	14	2000	356.0	356.0	35.0



www.ti.com 7-Dec-2024

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
7802601FA	W	CFP	16	25	506.98	26.16	6220	NA
JM38510/32701B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/32702B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/32702BDA	W	CFP	14	25	506.98	26.16	6220	NA
JM38510/32702SDA	W	CFP	14	25	506.98	26.16	6220	NA
M38510/32701B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
M38510/32702B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
M38510/32702BDA	W	CFP	14	25	506.98	26.16	6220	NA
M38510/32702SDA	W	CFP	14	25	506.98	26.16	6220	NA
SN74LS390D	D	SOIC	16	40	507	8	3940	4.32
SN74LS390N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS390N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS390NE4	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS390NE4	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS393N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS393N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS393NE4	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS393NE4	N	PDIP	14	25	506	13.97	11230	4.32
SNJ54LS390FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS390W	W	CFP	16	25	506.98	26.16	6220	NA
SNJ54LS393FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS393W	W	CFP	14	25	506.98	26.16	6220	NA



SOP



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



SOF



NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOF



NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.





SMALL OUTLINE INTEGRATED CIRCUIT



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
- 5. Reference JEDEC registration MS-012, variation AB.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16



8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
 Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2024, Texas Instruments Incorporated